

# 5MHz-8000MHz

**BSW7321** 

### **Product Description**

The BSW7321 is a reflective SPDT RF switch that can be used in high power and good performance WLAN 802.11 a/b/g/n/ac/ax, DOCSIS 3.0/3.1 and Wireless Communication applications.

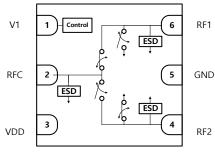
This device is packaged in RoHS2-compliant with 1.5mm x 1.5mm x 0.5mm, 6-Lead UDFN package. It must be used with back side ground soldering.

The BSW7321 has robust ESD protection circuits at all pins and temperature performance (operating temperature range : -40 to +105°C).

This switch does not require blocking capacitors. If DC is presented at the RF port, add a blocking capacitor. This device also has a high linearity performance over all temperature range such as IIP3, IIP2.

A functional block diagram is shown in Figure 1.

## **Block Diagram**



**Figure 1 Functional Block Diagram** 

## **Applications**

- WIMAX 802.16
- WLAN 802.11 a/b/g/n/ac/ax
- DOCSIS 3.0/3.1
- Drone
- Bluetooth
- Wireless Infrastructure
- Remote keyless entry
- Telematics / Infotainment
- Two-way radios
- Wireless control systems
- GPS/Navigation

### Package Type



1.5mm x 1.5mm x 0.5mm, 6-Lead UDFN Package Figure 2 Package Type

### **Device Features**

- Output frequency range : 5 MHz to 8.0 GHz
- Fast Switching Time : 105 to 145 ns
- Supply Voltage : 2.7V to 3.6V
- Low insertion loss : 0.58dB @ 2.45GHz
  - : 0.86dB @ 5.75GHz
- High isolation
- : 43dB @ 2.45GHz
  - : 30dB @ 5.75GHz
- Input 1 dB output compression
  - : 39dBm @ 2.45GHz
  - : 39dBm @ 5.75GHz
- High IIP3
  - : 65dBm @ 2.45GHz
  - : 65dBm @ 5.75GHz
- ESD protection (HBM) : 2.0kV @ all pins
- 6-Lead UDFN package : 1.5mm x 1.5mm x 0.5mm
- Operating temperature range : -40°C to +105°C
- Lead-free/RoHS2-compliant UDFN package





## **Electrical Specifications**

Typical conditions are at VDD = 3.3V,  $T_A = 25^{\circ}$ C, V1 Low = 0V, V1 High = 3.3V,  $Z_L = 50\Omega$ , Excluding SMA Connector and PCB loss<sup>(1)</sup>, unless otherwise noted.

#### **Table 1 Electrical Specifications**

Parameter	Path	Condition	Min	Тур	Max	Unit
Operating Frequency			5		8000	MHz
		1GHz		0.50		
		2GHz		0.57		
		3GHz		0.61		
Insertion Loss	RFC - RFx	4GHz		0.59		dB
		5GHz		0.65		ub.
		6GHz		0.97		
		7GHz		0.88		
		8GHz		0.96		
		1GHz		52		
		2GHz		46		
		3GHz		30		
Isolation	RFC - RFx	4GHz		35		dB
130101011		5GHz		32		ub
		6GHz		30		
		7GHz		29		
		8GHz		26		
		1GHz		44		
	RFx - RFx	2GHz		36		dB
		3GHz		33		
Isolation		4GHz		30		
ISUIALIUTI		5GHz		29		ив
		6GHz		26		
		7GHz		25		
		8GHz		23		
Return Loss	RFC, RF1, RF2	5MHz – 8GHz (Active port)		15		dB
	250.25	2.45GHz		39		10
Input P1dB	RFC - RFx	5.75GHz		39		dBm
		2.45GHz		65		
Input IP3 <sup>(2)</sup>	RFC - RFx	5.75GHz		65		dBm
(2)		2.45GHz		100		
Input IP2 <sup>(2)</sup>	RFC - RFx	5.75GHz		100		dBm
		2.45GHz		90		
2 <sup>nd</sup> Harmonic <sup>(3)</sup>	RFC - RFx	5.75GHz		90		dBc
- rd (2)		2.45GHz		105		
3 <sup>rd</sup> Harmonic <sup>(3)</sup>	RFC - RFx	5.75GHz		105		dBc
		50% control to 90% RF		145		1
Switching Time	RFC - RFx	50% control to 10% RF		105		ns
		50% CTRL to 0.05dB final value Rising Edge		155		
Settling Time	RFC - RFx	50% CTRL to 0.05dB final value Falling Edge		115		ns

The typical spurious performance of the BSW7321 is -115dBm / 10Hz @ Over 10MHz

(1) Excluding SMA Connector and PCB loss.

1GHz (0.14dB), 2GHz (0.22dB), 3GHz (0.27dB), 4GHz (0.36dB), 5GHz (0.41dB), 6GHz (0.45dB), 7GHz (0.59dB), 8GHz (0.64dB)

(2) The two-tone Power is 18dBm each and Tone spacing is 20KHz.

(3) Tone Power is 18dBm.

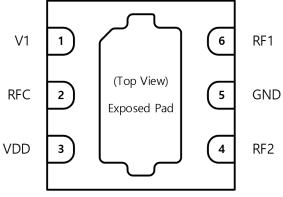
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## **Product Description**



**Figure 3 Functional Block Diagram** 

### Table 3 V1 Control Truth Table

#### Table 2 Pin Descriptions

No.	Pin Name Descriptions		
1	V1	Digital Control Logic Input	
2	RFC	RF Common port	
3	VDD	Supply Voltage	
4	RF2	RF2 port	
5	GND	Ground	
6	RF1	RF1 port	
Pad	Exposed Pad	Ground	

V1	RFC-RF1	RFC-RF2
0	OFF	ON
1	ON	OFF

#### **Table 4 Recommended Operating Conditions\***

Parameter	Symbol	Min	Тур	Max	Unit
Supply Voltage	VDD	2.7	3.3	3.6	V
Supply Current	IDD	-	170	-	μΑ
Digital Input Control (1/1)	V1 High	1.0	-	3.3	V
Digital Input Control (V1)	V1 Low	0	-	0.7	V
Operating Temperature Range	То	-40	+25	+105	°C
RF Input Power, CW Freq.=2.45GHz, 5.75GHz Any port, Ζ <sub>L</sub> =50Ω	-	-	-	30	dBm

\*Specifications are not guaranteed over all recommended operating conditions.

### **Table 5 Absolute Maximum Ratings**

Parameter		Symbol	Min	Max	Unit	
Supply Voltage		VDD	-0.3	3.6	V	
Digital Input Voltage (V1)		V1	-0.3	3.6	V	
Maximum Input Power, CW (+25°C)		-	-	Input P1dB	dBm	
Storage Temperature range		-	-65	+150	°C	
Maximum Junction Temperature		-	-	+150	°C	
	HBM	All pins	-	-	2000	V
ESD	CDM	All pins	-	-	1000	V

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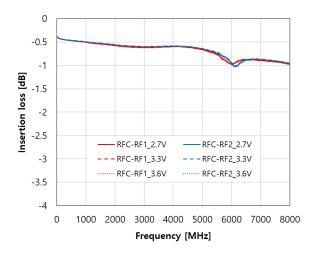
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### **Typical Performances**

Typical conditions are at VDD = 3.3V,  $T_A = 25^{\circ}$ C, V1 Low = 0V, V1 High = 3.3V,  $Z_L = 50\Omega$ , Excluding SMA Connector and PCB loss, unless otherwise noted.

### Figure 4 Insertion Loss vs. Vdd (RFC - RFx)



#### Figure 5 Insertion Loss vs. Temp (RFC - RFx)

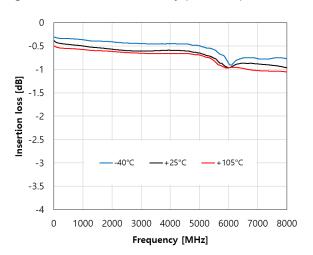


Figure 6 Return Loss (RFC, RFx)

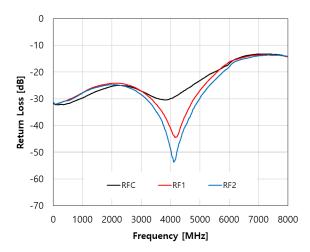
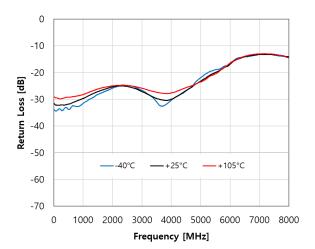


Figure 7 Return Loss vs. Temp (RFC)





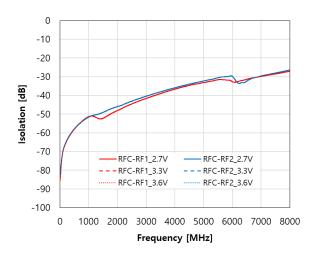
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### Figure 8 Isolation vs. Vdd (RFC - RFx)



### Figure 9 Isolation vs. Temp (RFC-RFx)

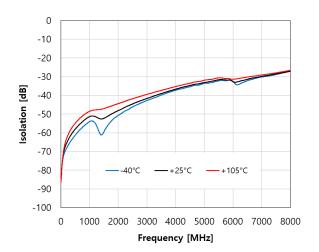


Figure 10 Isolation vs. Vdd (RFx - RFx)

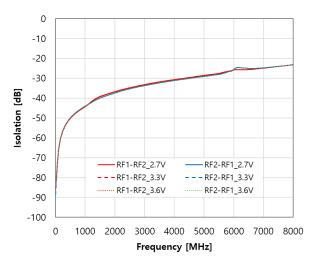
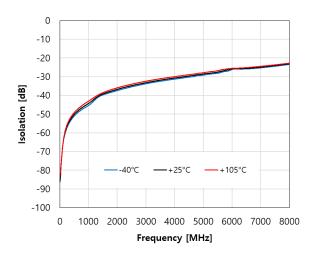


Figure 11 Isolation vs. Temp (RFx - RFx)

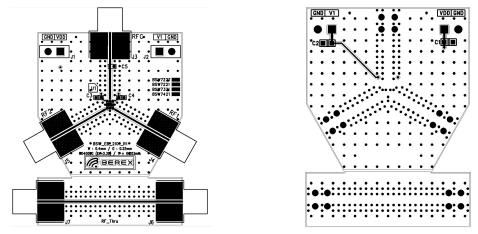




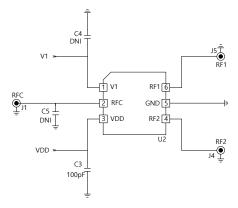
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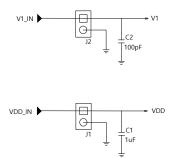
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## **Evaluation Board**



**Figure 12 Evaluation Board Layout** 





### Figure 13 Evaluation Board Schematic

	]
RO4003C Er : 3.38	
FR-4 Er : 4.5~4.8	
FR-4 Er : 4.5~4.8	
	1

COPPER : 1oz (0.035mm), Top La	<u>yer</u>
RO4003C / 0.2mm	
COPPER : 1oz (0.035mm), Inner 1	Layer
FR-4 / 0.36mm	FINISH THICKNESS : 1.63T
COPPER : 1oz (0.035mm), Inner 2	Layer
FR-4 / 0.93mm	
COPPER : 1oz (0.035mm), Bottom	Layer

	No.	Ref Des	Part Qty	Part Number	Remark
	1	C1	1	1 CAP 1005 1uF J 50V	
	2	C2,C3*	2	2 CAP 1005 100pF J 50V	
	3	C4	2	CAP 1005 DNI	
	4	C5	1	CAP 0603 DNI	
	6	J1,J2	2	2 Pin Header	
	7	RFC, RF1, RF2	3	SMA_END_LAUNCH	
ĺ	8	U1	1	BSW7321	

#### Figure 14 Evaluation Board PCB Layer Information

\* C3 should be placed near the device.

### Table 6 Bill of Material - Evaluation Board

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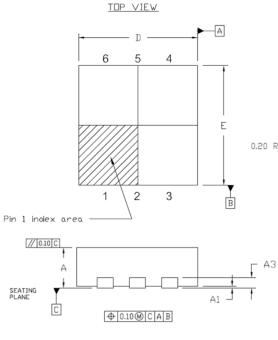
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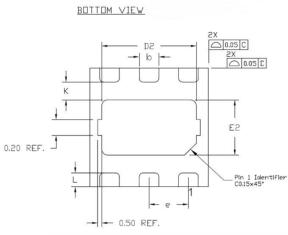


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## **Package Outline Drawing**





Ŋ≻∑¤□」	Common					
B	DIMENSI	ONS MILLI	METER	DIME	ENSIONS IN	КН
	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
Α	0.45	0.50	0.55	0.018	0.020	0.022
A3	0.127 REF.			0.0	005 REF	
A1	0.00	0.02	0.05	0.000	0.001	0.002
b	0.20	0.25	0.30	0.008	0.010	0.012
D	1.45	1.50	1.55	0.057	0.059	0.061
D2	1.15	1.20	1.25	0.045	0.047	0.049
E	1.45	1.50	1.55	0.057	0.059	0.061
E2	0.65	0.70	0.75	0.026	0.028	0.030
e	0.500 BSC			0.	020 BS	С
L	0.125	0.175	0.225	0.005	0.007	0.009
К	0.230	-	-	0.009	-	-

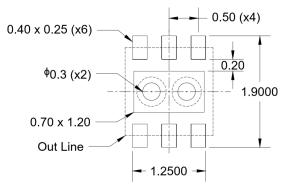
# Dimension and tolerancing conform to ASME Y14.5M-1994. Controlling Dimensions : Millimeter. Converted INCH dimension

NOTES :

- are not necessarily exact.
- Dimension b applied to Metallized terminal and is measured between 0.15 to 0.30mm from terminal tip.

<u>SIDE VIEW</u>

### Figure 15 Package Outline Drawing



\*Dimensions (mm)

#### Figure 16 Recommended Land Pattern

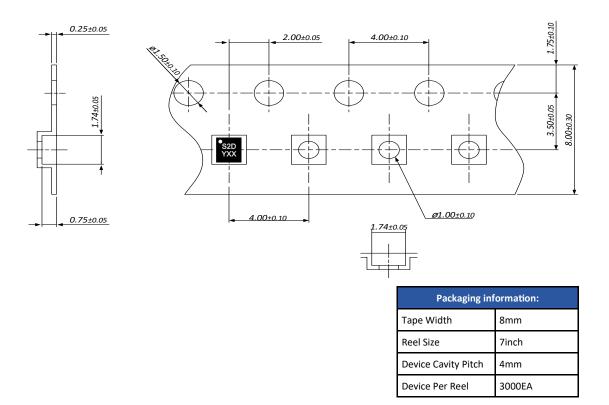
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## Tape & Reel





## **Package Marking**



Marking information:					
	Marking Code 1		Marking Code 2		
S	RF Switch	2 The number of switch throw			
2	The number of switch throw	D	Sequential Number		
D	D Sequential Number		Wafer Lot Number		
Y	Work Year				
хх	Wafer Lot Number				

### Figure 18 Package Marking

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### Lead plating finish

#### 100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

### MSL / ESD Rating

ESD information:				
Rating	Class 2 (2000V)			
Test	Human Body Model (HBM)			
Standard	JS-001-2017			

MSL information:	
Rating	Level 1 at +260°C convection reflow
Standard	JEDEC Standard J-STD-020



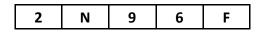
Proper ESD procedures should be followed when handling the device.

## **RoHS Compliance**

This part is compliant with Restrictions on the use of certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU.

This product also is compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1%(w/w) in each components of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

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